

Special Issue

Microstructures and Materials for Additive Manufacturing

Message from the Guest Editor

It is our pleasure to announce the opening of a new Special Issue in the *Applied Sciences* Journal. The main topics of the Issue will be regarding “Microstructures and Materials for Additive Manufacturing”. The Special Issue wants to contribute to the field, presenting the most relevant advances in this research area. The following are some of the topics proposed for this Special Issue:

- Innovative materials for additive manufacturing;
- Recent developments in polymers, metals, ceramics, concrete and composites for additive manufacturing;
- Novel techniques for microstructure analysis of 3D printed materials;
- Effects of microstructure on physical, mechanical and thermal properties of 3D printed materials.

Guest Editor

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Deadline for manuscript submissions

closed (31 October 2021)



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About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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